

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No.: 10/789,914

Filing Date: February 27, 2004

Applicant: Hosomi et al.

Group Art Unit: 1714

Examiner: Kriellion Sanders

Title: Resin Composition, Prepeg, Laminate and Semiconductor Package

Attorney Docket: 2497-000002/CP

Mail Stop: Petitions
Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

PETITION TO CLAIM BENEFIT UNDER 35 USC 365(C) OF AN INTERNATIONAL APPLICATION DESIGNATING THE UNITED STATES OF AMERICA UNDER 37CFR 1.78(a)(3)

PETITION UNDER 37 CFR 1.55(c)TO ACCEPT A DELAYED CLAIM FOR PRIORITY UNDER 35 USC 119(b)

Sir:

Applicant hereby petitions to claim the benefit for this application under 35 USC 365(c) of international application designating the United States no.: PCT/JP02/08845, International filing date: 30 August 2002.

Applicant states that the entire delay between the date the claim for the benefit of the earlier application was due under paragraph (a)(2)(ii) of 37 CFR 1.78 and the date this claim is filed was unintentional.

Applicant hereby petitions, in accordance with 1.55(c), to accept a claim of priority of this application under 35 USC 119(b) from foreign application no.: JP 2001 264385, filing date: 31 August 2001.

Applicant states that the entire delay between the date the claim for priority was due under paragraph (a)(1) of 37 CFR 1.55 and the date this claim is filed was unintentional.

The surcharge fee set forth in §1.17(f) required by 37 CFR 1.55(c)(1), is paid by Deposit Account No. 08-0750.

Applicant also submits a signed Supplemental Application Data Sheet that includes the priority claims.

If it is believed that personal communication will expedite this matter, please telephone the undersigned at (248) 641-1600.

Respectfully submitted,

Dated: January 10, 2001

By: 

Robert M. Siminski
Reg. No. 36,007

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RMS/jao